PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yuhi KONDO	03/22/2011
Takefumi NAGUMO	03/22/2011
Jun LUO	03/25/2011

RECEIVING PARTY DATA

Name:	Sony Corporation	
Street Address:	1-7-1 Konan, Minato-ku,	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13082920

CORRESPONDENCE DATA

Fax Number: (202)408-4400

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 202-408-4000

Email: michael.hamilton@finnegan.com

Correspondent Name: FINNEGAN, HENDERSON, FARABOW, GARRETT &

Address Line 1: 901 NEW YORK AVENUE, NW

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20001-4413

ATTORNEY DOCKET NUMBER: 09812.2317

NAME OF SUBMITTER: David W. Hill

Total Attachments: 1

source=Assign2317#page1.tif

PATENT REEL: 026098 FRAME: 0720 \$40.00 13082

501495678

Attorney Docket No. 09812.2317 SONY Ref. No.: \$11P0819US00

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PROCESSING DEVICE, IMAGE PROCESSING METHOD, AND PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged. It as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without lurther remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense:

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

the spaces that follow: Serial Number:	Filing Date:
This assignment executed on the dates indicated below.	
YUHI KONDO	
Name of first or sole inventor TOKYO JAPAN	Execution date of U.S. Patent Application
Residence of First or sole inventor	
Unchi Kondo	March 22, 2011
Signalure of first or sole inventor	March 22 2011 Date of this assignment
TAKEFUMI NAGUMO	
Name of second inventor	Execution date of U.S. Patent Application
KANAGAWA JAPAN	··
Residence of second inventor	
Takeprio Nagumo	March 22. 2011
Signature of second inventor	Date of this assignment
JUN LUO	
Name of third inventor	Execution date of U.S. Patent Application
TOKYO JAPAN	
Residence of third inventor	March 25. 2011
Jun Luo	Atant 7 4 1511
Signature of third inventor	Date of this assignment
	March 25, 2011 1.1.

PATENT REEL: 026098 FRAME: 0721